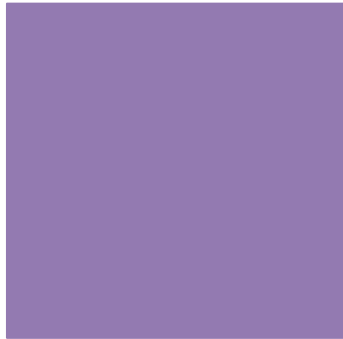


# Indirect Rapid Prototyping

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Micro e Nano Sistemi

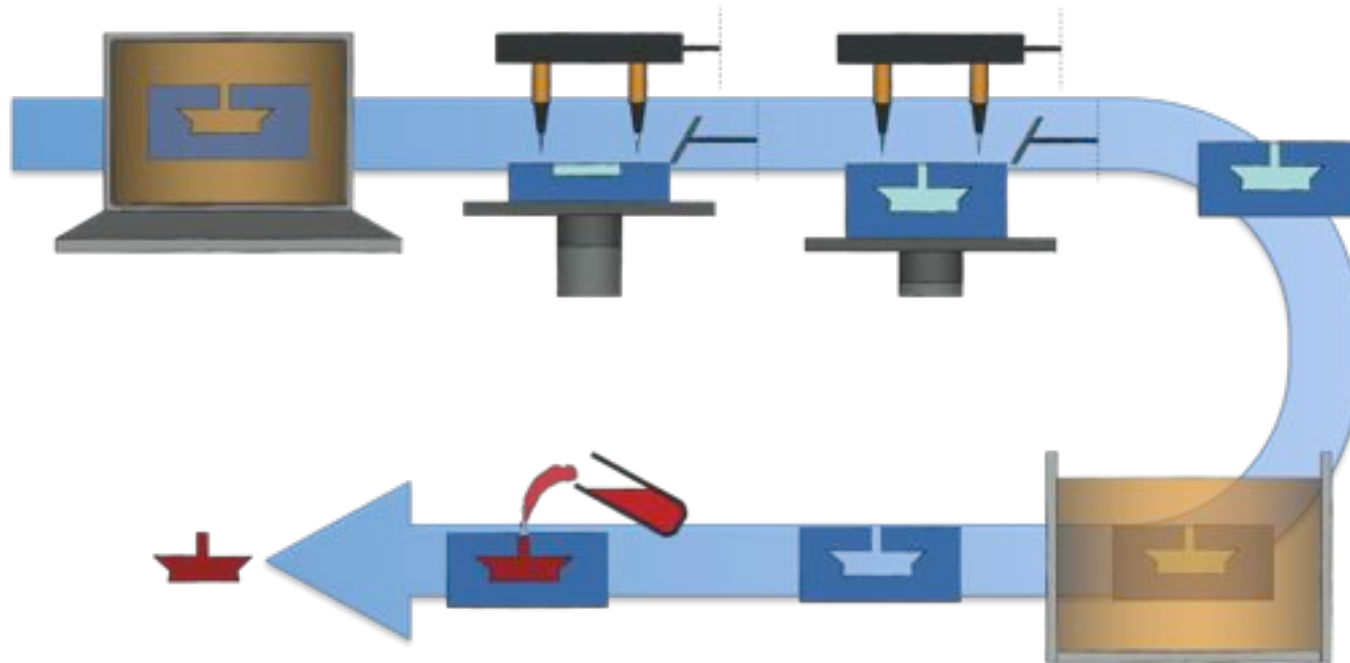


[carmelo.demaria@centropiaggio.unipi.it](mailto:carmelo.demaria@centropiaggio.unipi.it)

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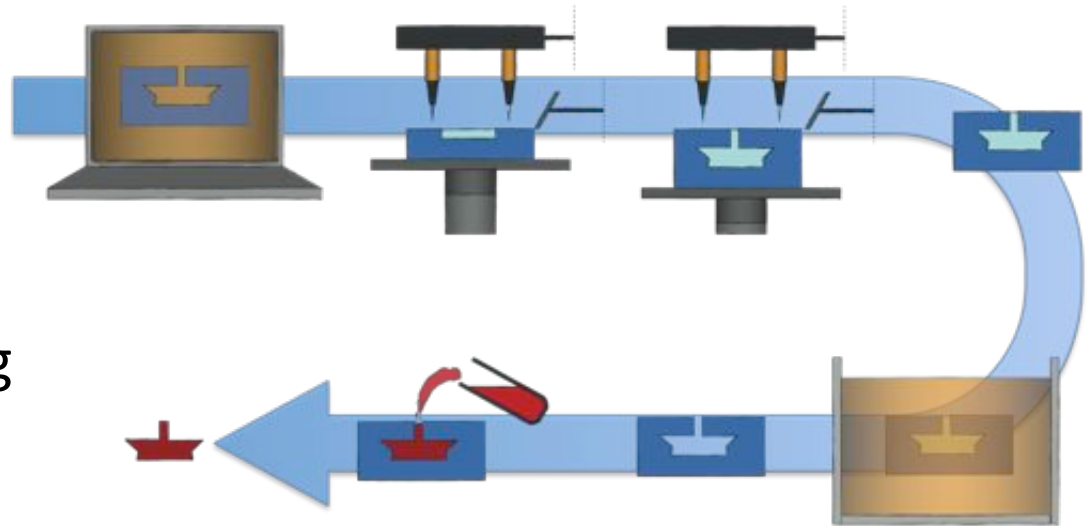
# Indirect Rapid Prototyping (iRP)

- Molds realised with RP devices (CAD/CAM)
- Casting of the desired (bio-)material
- Extraction of the final object



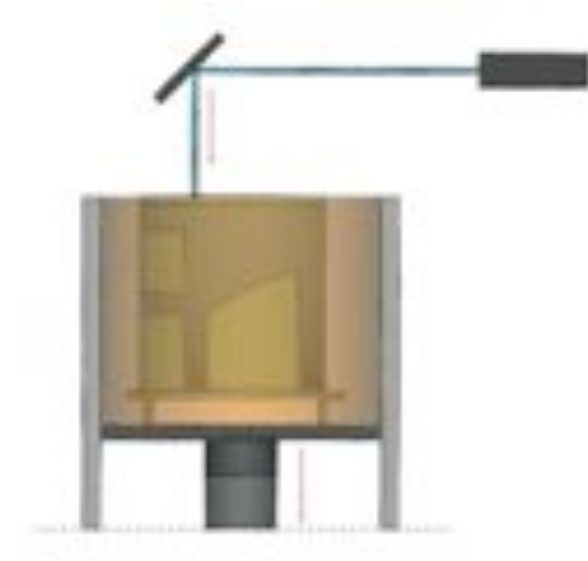
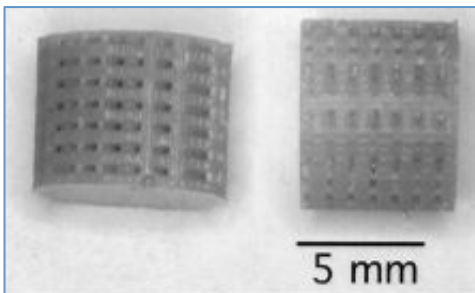
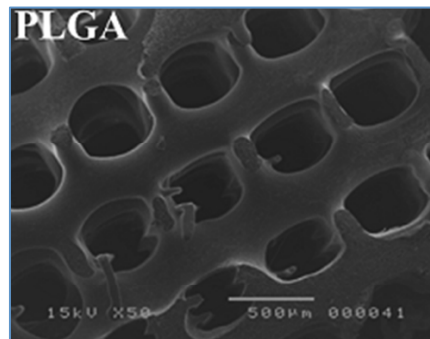
# + iRP – General concepts

- Wide range of (bio-)materials
- Known also as rapid tooling
- Less waste
- High fidelity
- Microporosity by:
  - critical point drying
  - free-drying
  - leaching
- Use in surgery room



# + iRP – Stereolithography

Casted Materials	Extraction method	Resolution ( $\mu\text{m}$ )
Thermoplastic Elastomer	Mechanical	$\approx 1000$
HA	Pyrolysis	400
PCL, PLLA, PLGA, Chitosan, alginate	Basic Solution	200-400



R Sodian et al., *ASAIO Journal*, 48(1), 2002

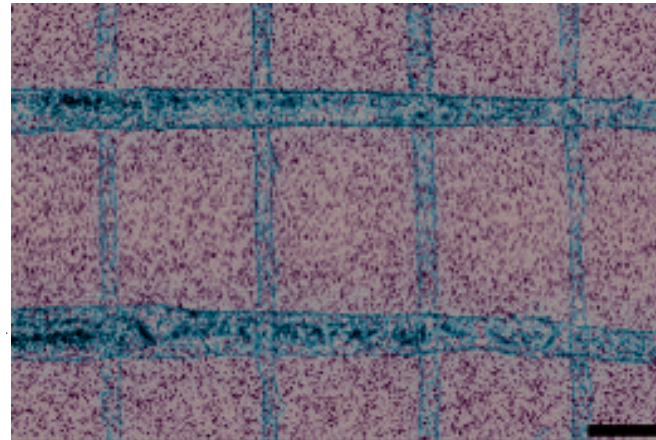
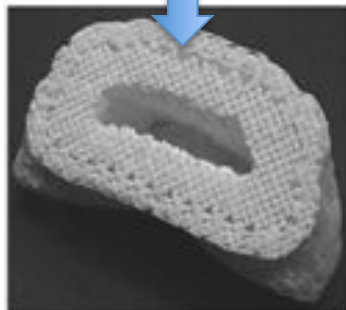
T-MG Chu et al., *Journal of Materials Science: Materials in Medicine*, 12:471–478, 2001

YJ Seol *Microelectronic Engineering*, 86(4-6):1443–1446, Apr 2009

HW Kang and DW Cho. *Tissue Eng Part C Methods*. 2012 Sep;18(9):719-29

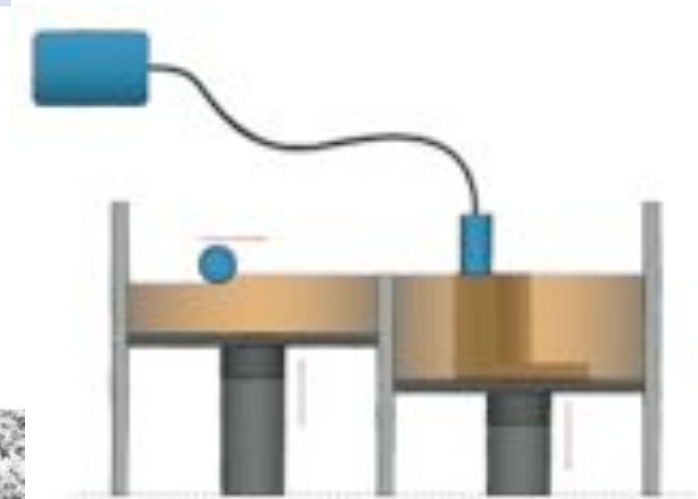
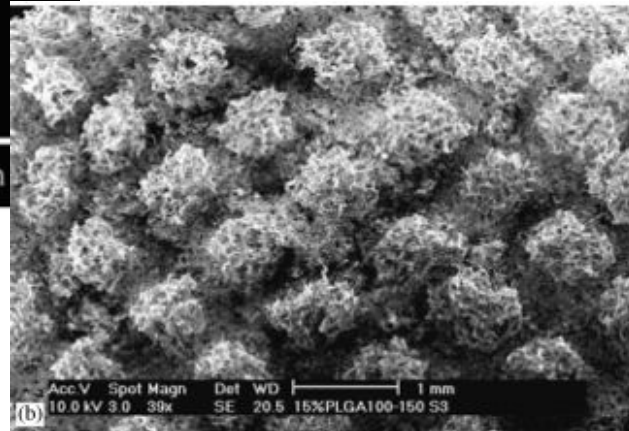
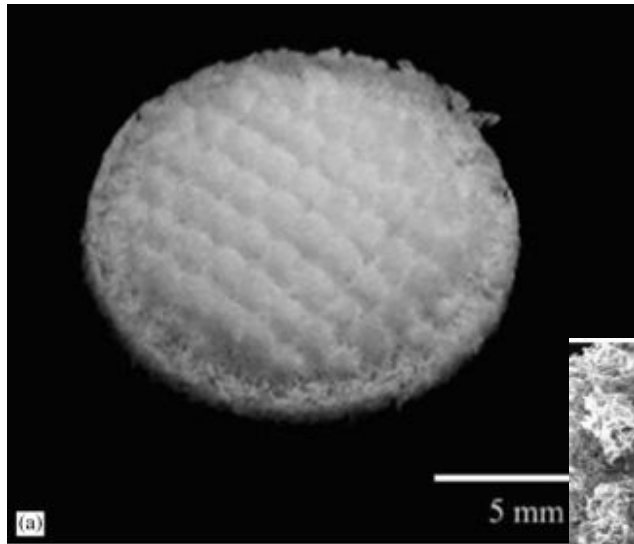
# + iRP – Fused Deposition Modeling

Casted Materials	Extraction method	Resolution ( $\mu\text{m}$ )
Alumina, TCP	Pyrolysis	300-500
Agarose, Alginate, PEG, Fibrin, Matrigel	Water dissolution	500



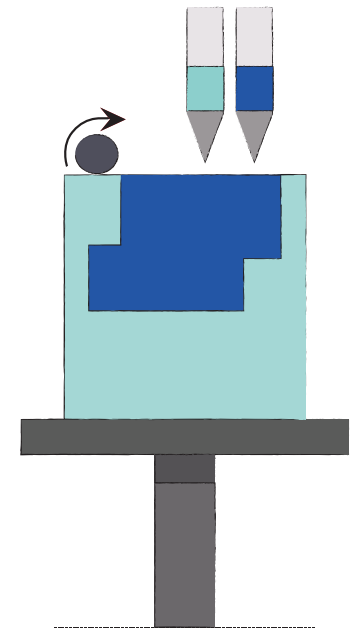
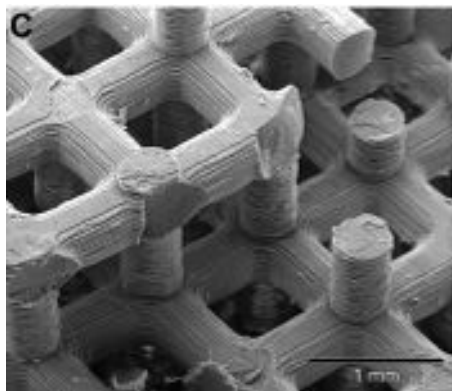
# + iRP – 3D printing

Casted Materials	Extraction method	Resolution ( $\mu\text{m}$ )
PLGA	Calcium Reagent	800



# + iRP – Ballistic

Casted Materials	Extraction method	Resolution ( $\mu\text{m}$ )
HA, TCP	Pyrolysis	300-400
Collagen, Silk, PLLA	Organic Solvent	200-400



E Sachlos et al., *Biomaterials*, 24(8):1487– 97, Apr 2003

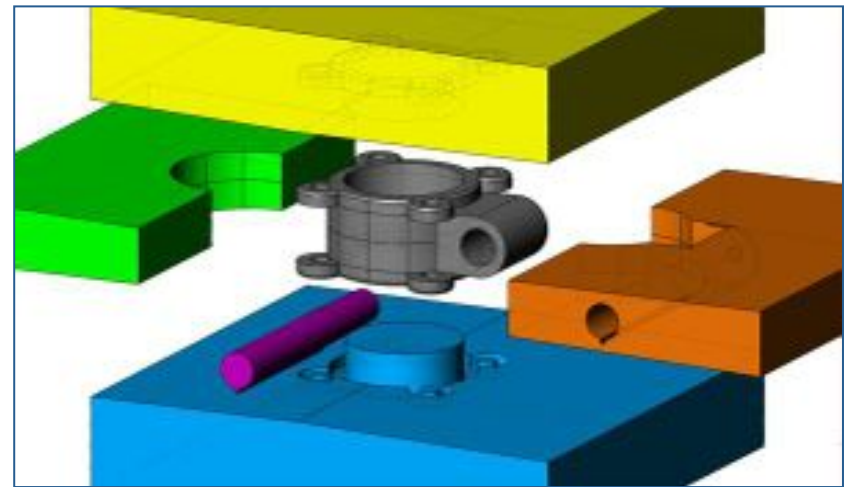
MJJ Liu et al., *Med Eng Phys*, Nov 2011

M Schumacher et al., *J Mater Sci: Mater Med*, 21(12):3119–3127, Dec 2010

JM Taboas et al., *Biomaterials*, 24(1):181 – 194, 2003

# + iRP – main problem

- Difficulty to extract the final object
  - Mechanical
  - Pyrolysis
  - (Organic) solvent



- IDEA:  
**CASTING INTO LOW MELTING POINT MOLDS**

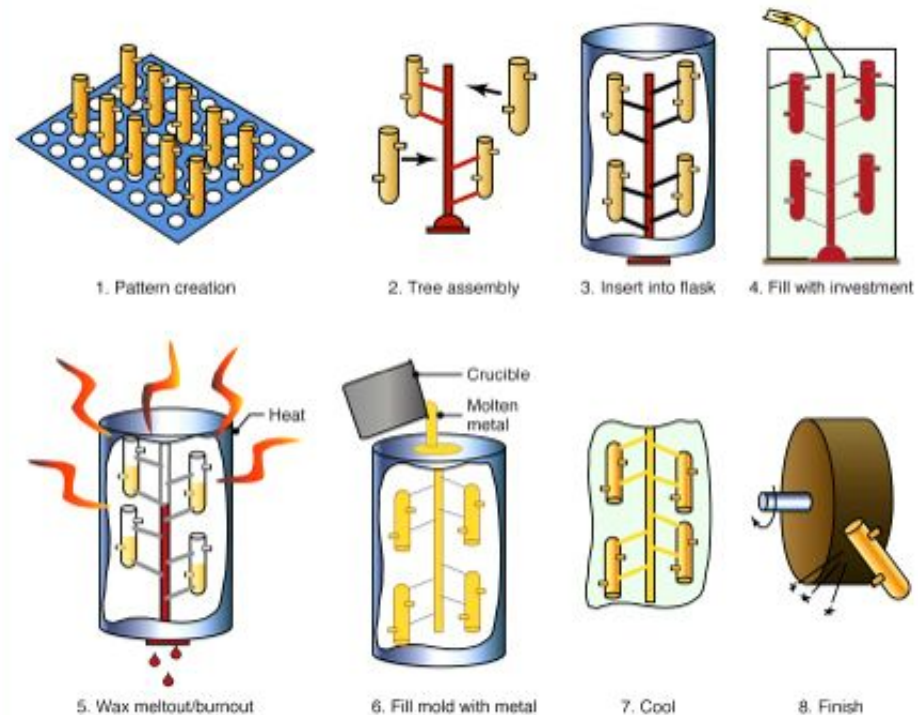




# Investment Casting Using Rapid-Prototyped Wax Parts



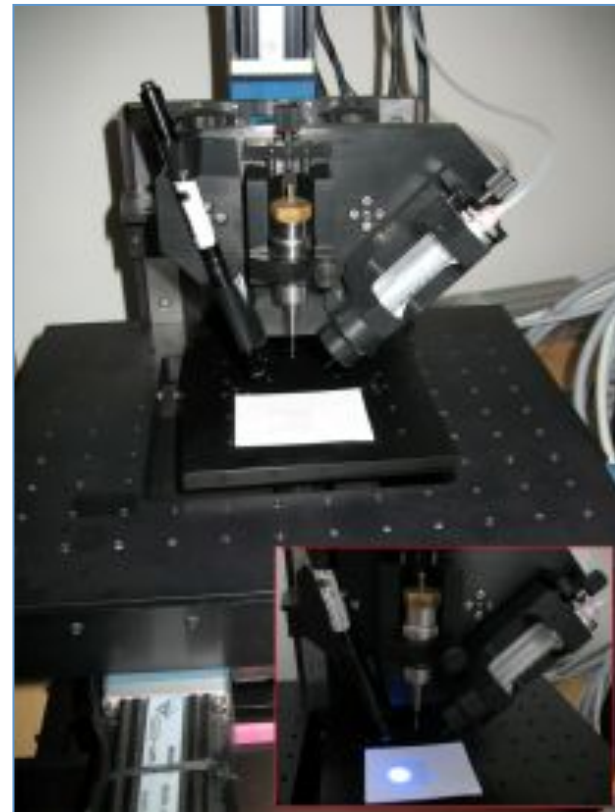
- Manufacturing steps for investment casting that uses rapid-prototyped wax parts as blanks. This method uses a flask for the investment, but a shell method also can be used. Source: Courtesy of 3D Systems, Inc.



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# PAM<sup>2</sup>

- Modular CAD/CAM system
- A 3-axes robotic stages:
  - position  $\pm 50$  mm;
  - velocity 0-15 mm/s;
  - resolution 1  $\mu$ m;
  - different extrusion modules;
  - layer-by-layer processing.



3D robotic stage

Pressure

Force

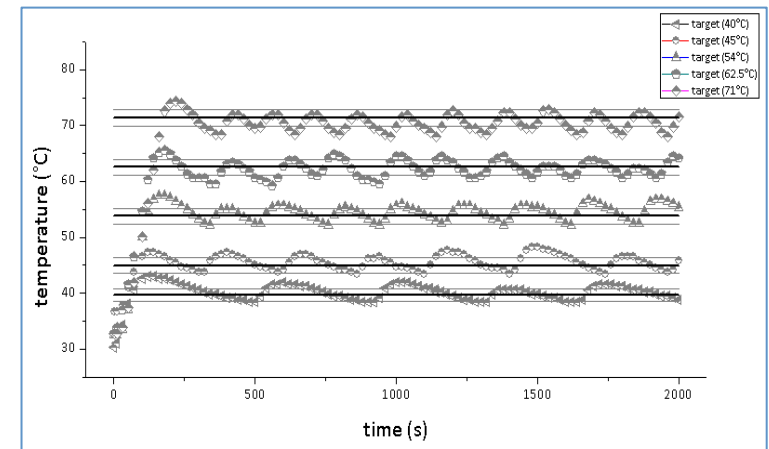
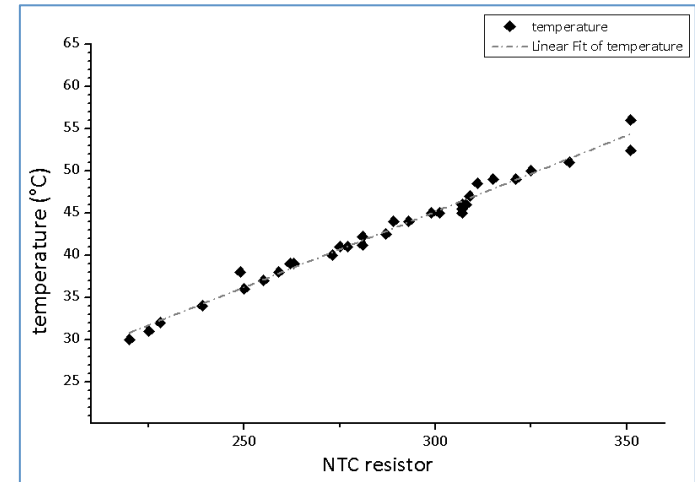
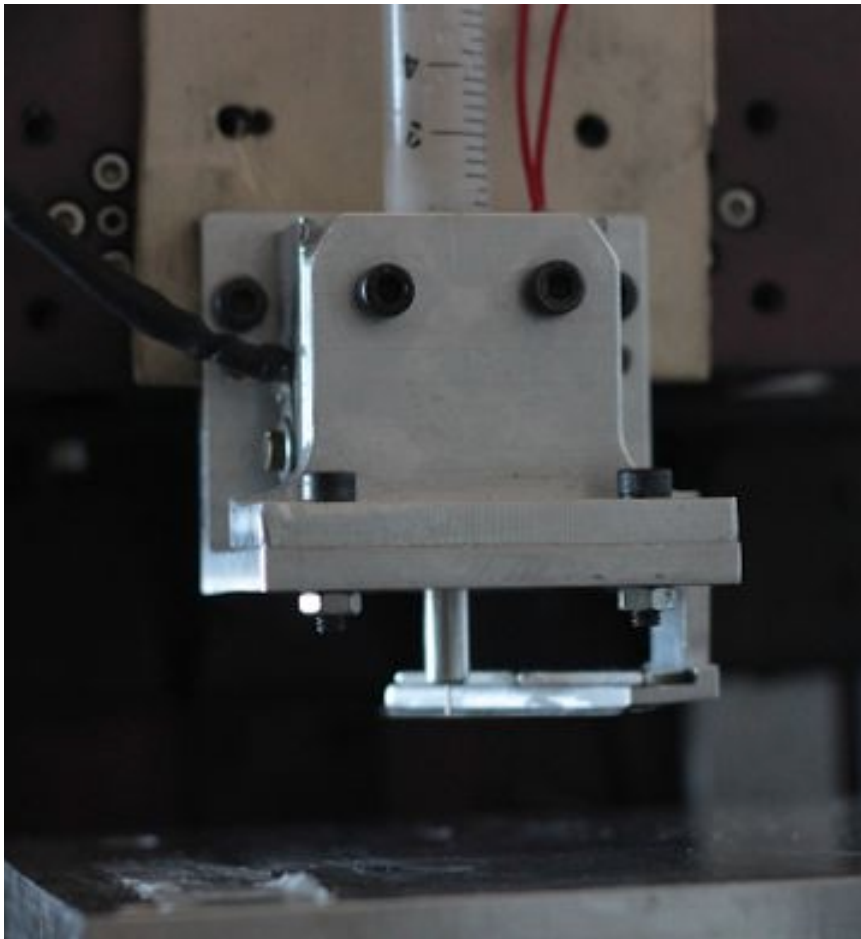
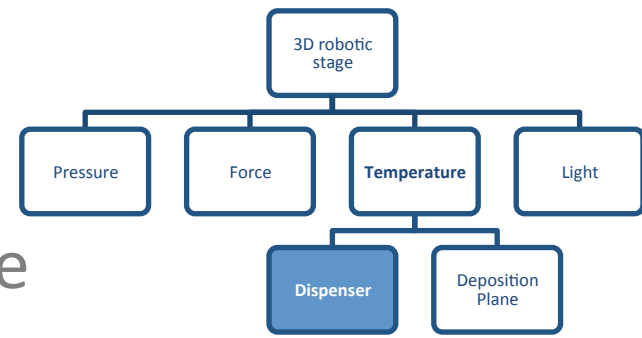
Temperature

Light

Tirella A, De Maria C, Criscenti G, Vozi G, Ahluwalia A. The PAM<sup>2</sup> system: a multilevel approach for fabrication of complex three-dimensional microstructures. Rapid Prototyping J 2012;18(4):5-5

# + TCS extrusion module

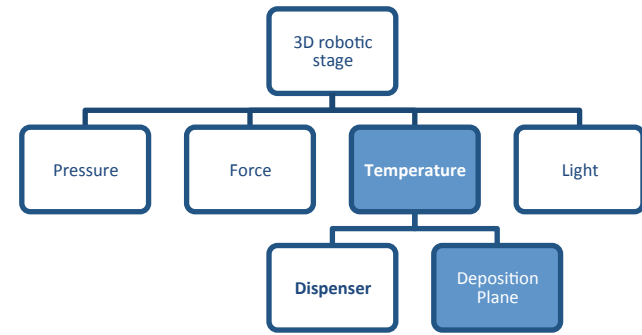
## Temperature Controlled Syringe



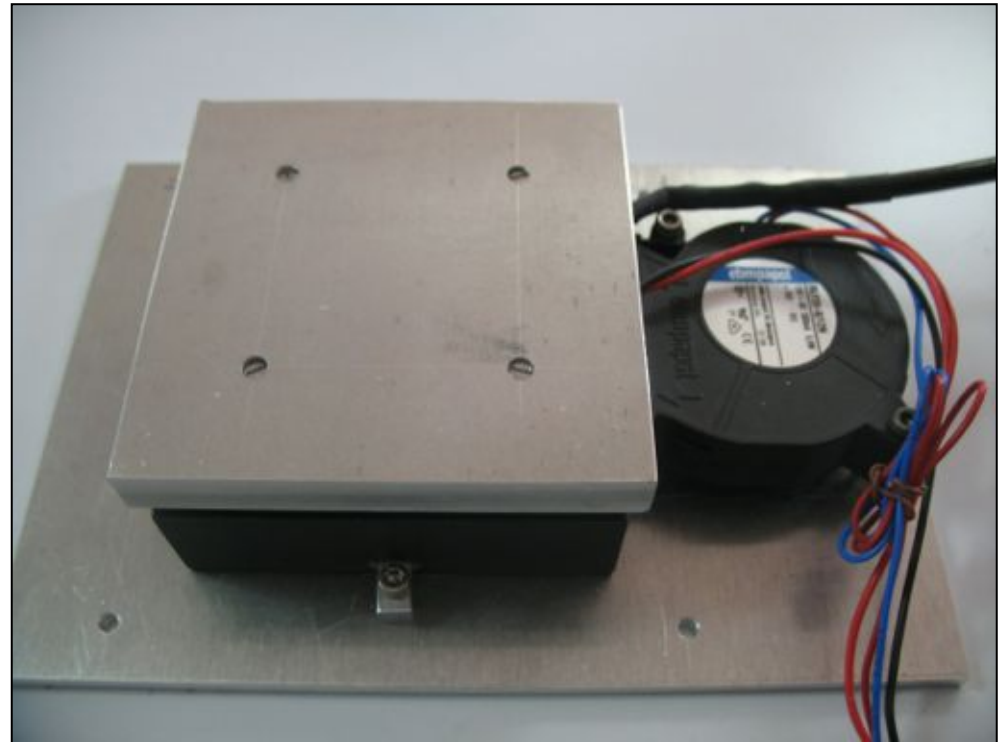
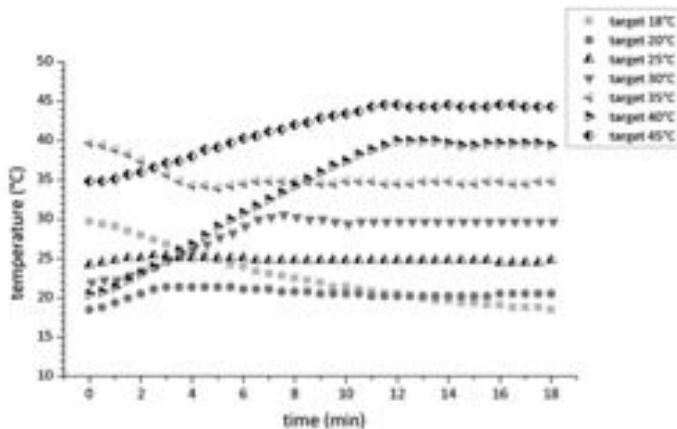
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# TCD module

Temperature Controlled  
Deposition plane



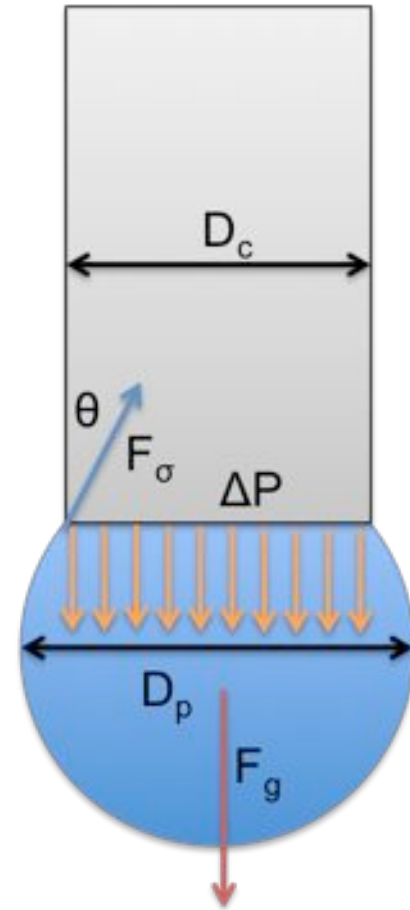
- Peltier Cell
- H-Bridge drivers
- Control algorithm based on step strategy
- $\pm 40^\circ\text{C}$  respect to room temperature





# **Plotting low melting point waxes**

# + Drop formation



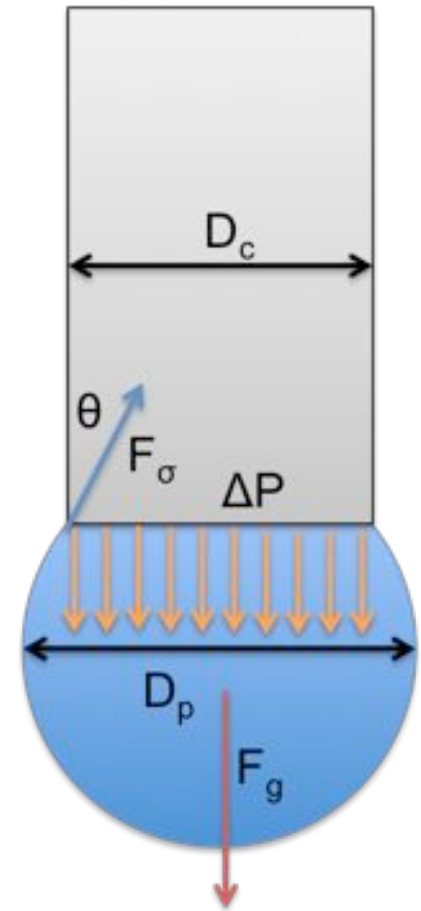
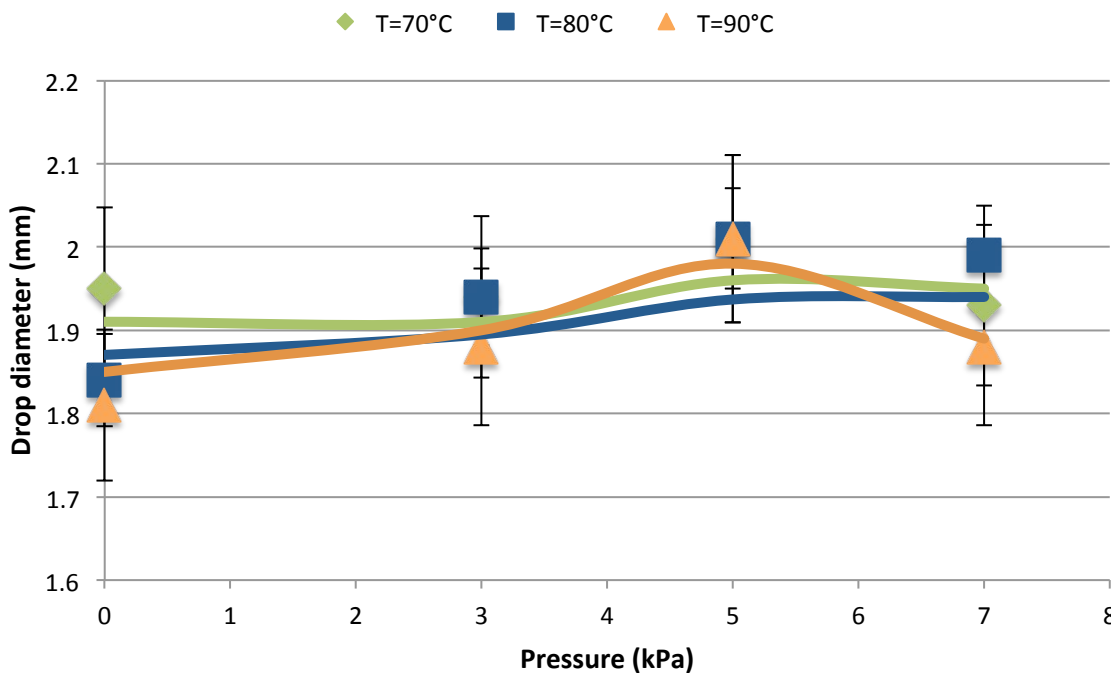
$$\frac{d(MV)}{dT} = \gamma(\pi D_0) \cos(\theta_c) \pm 2\pi\mu L \frac{V}{\ln\left(\frac{D}{D_0}\right)} - Mg$$



# Drop formation

- Just before drop detachment:

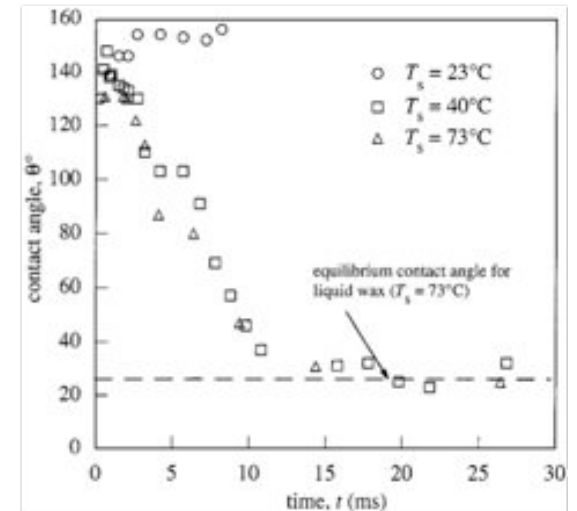
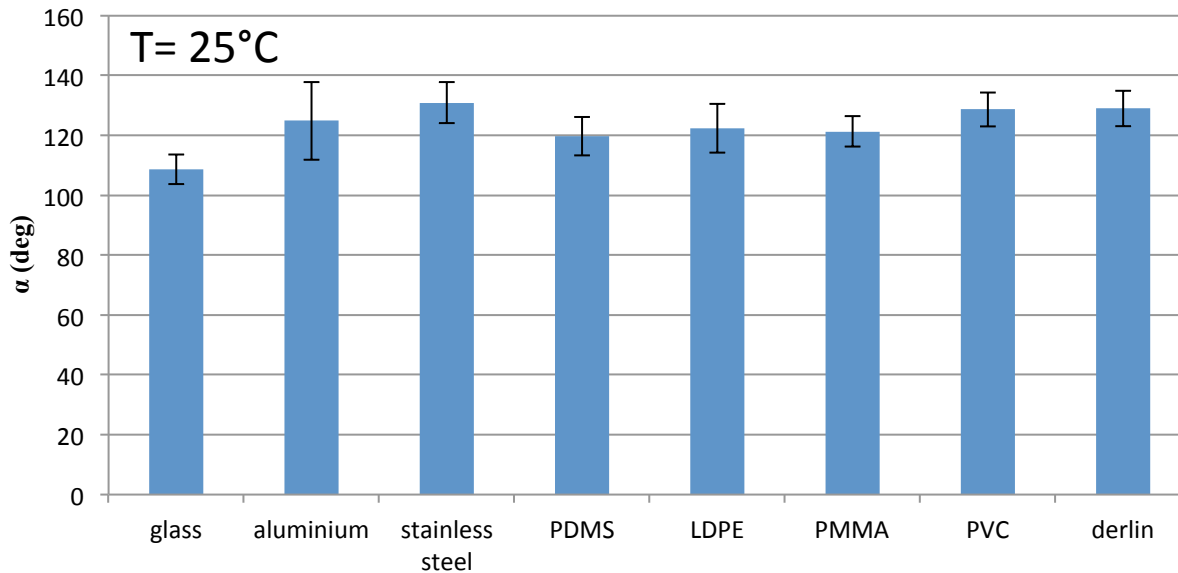
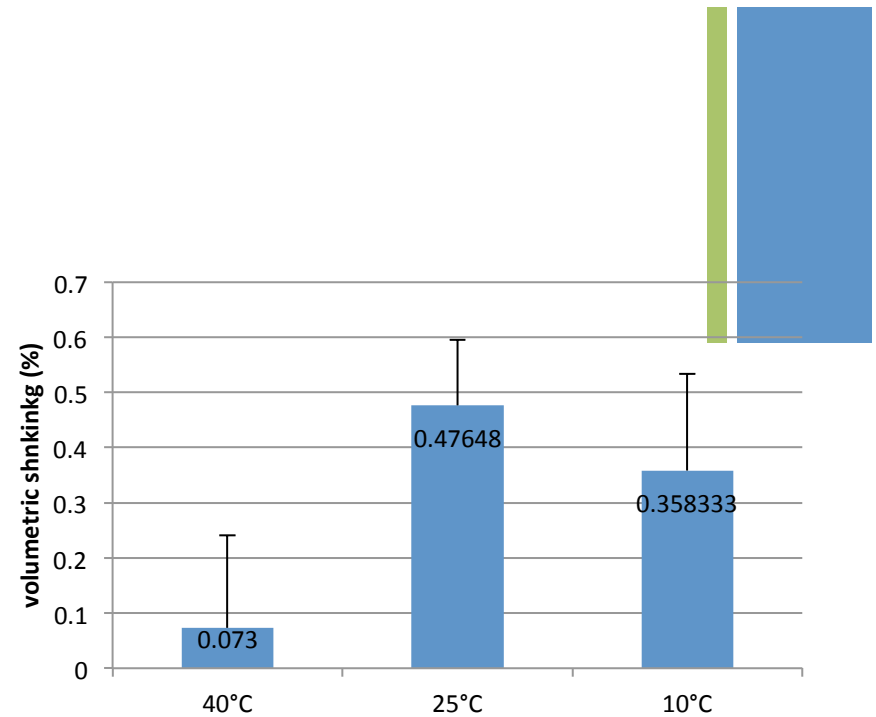
$$\gamma \pi D_0 \cos(\theta) = \rho g \left( \frac{\pi D^3}{6} \right)$$



# + System calibration

## preliminary tests

- Volumetric shrinking
  - Casting into an aluminium mold
- Contact angle
  - Several material tested

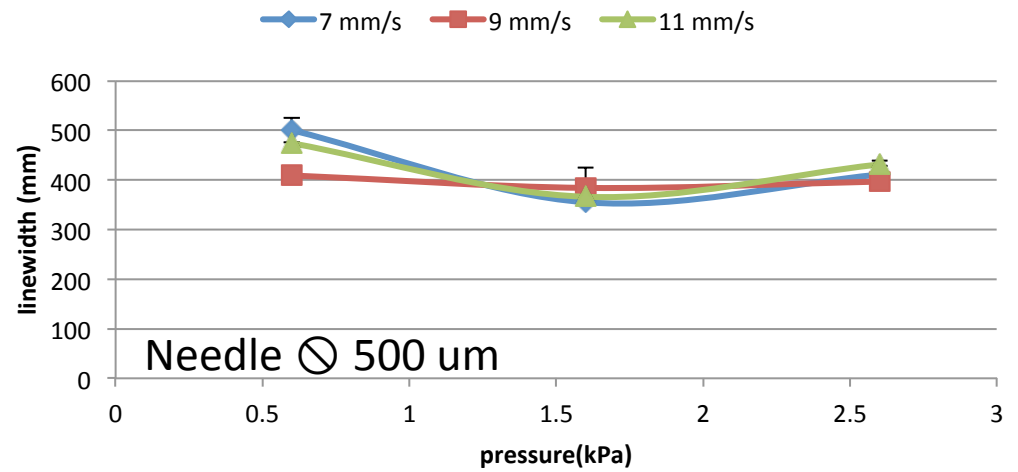
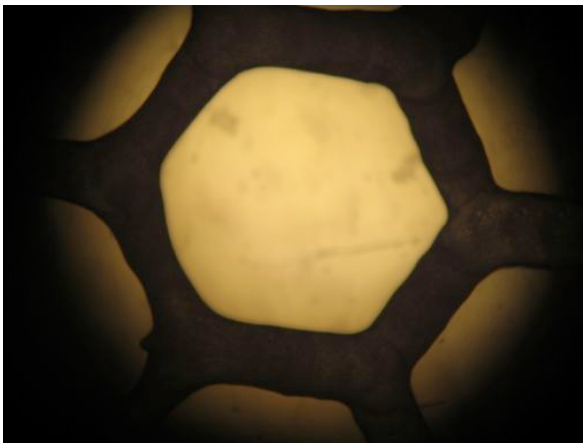
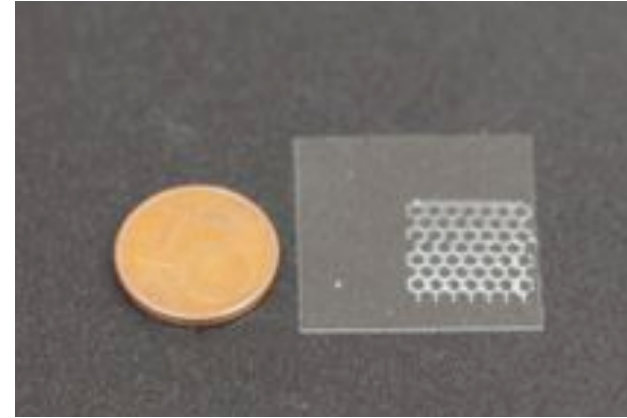
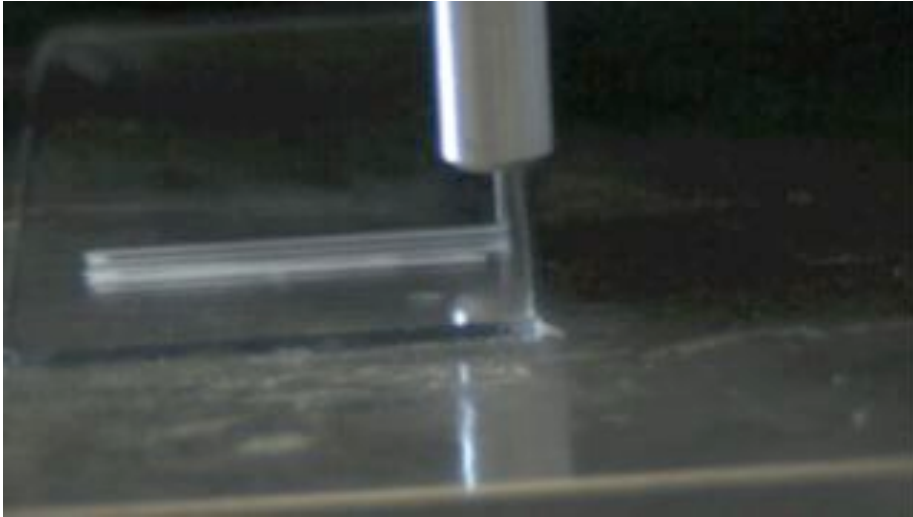


Bhola R, Chandra S, J. MATER SCI 34 (1999) 4883– 4894



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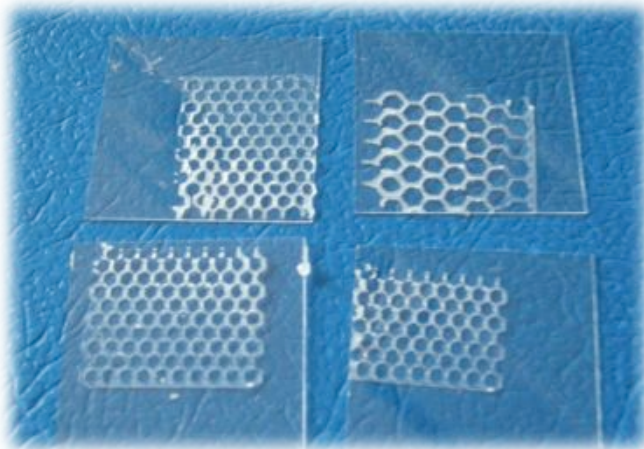
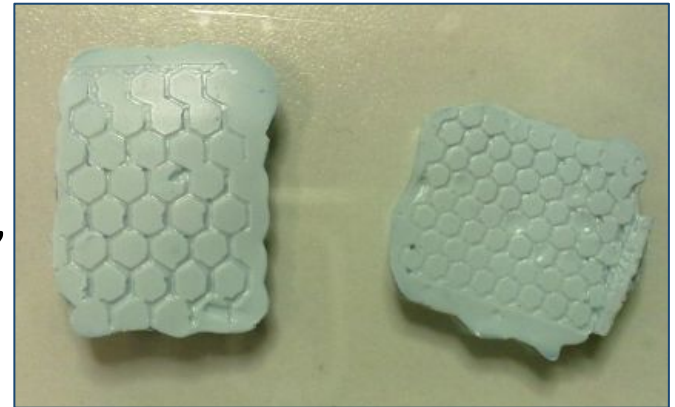
# Processing parameter in PAM<sup>2</sup>



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# Low melting point mold – 2D

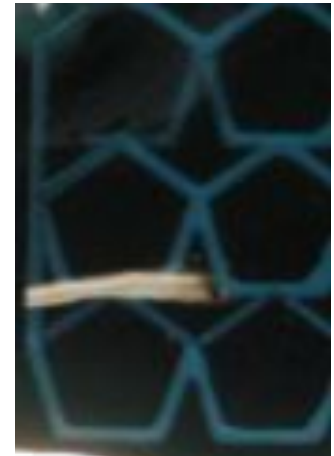
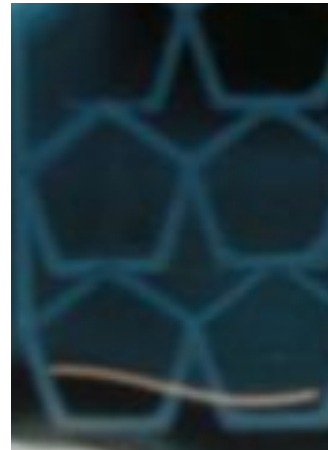
- Hexagonal path:
  - Side 2 mm, linewidth 400  $\mu\text{m}$
  - Side 1 mm, linewidth 300  $\mu\text{m}$
- 60% W/V HA in gelatin gel (5% W/V), crosslinked with genipin 0.5 W/V
- Volumetric change < 1%



+

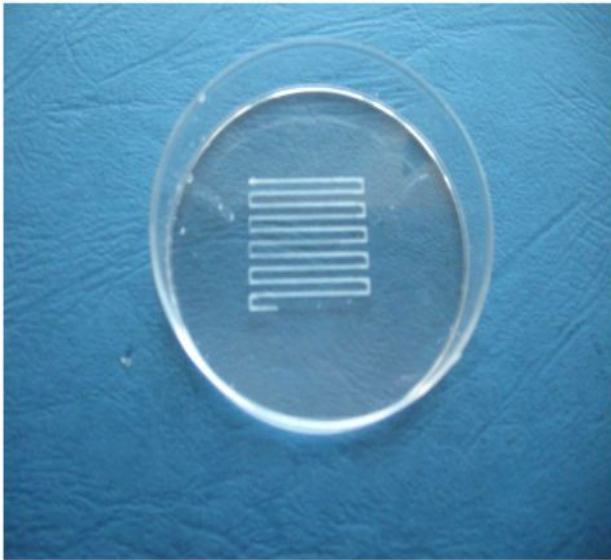
# Low melting point mold – 2D

- Hexagonal path:
  - Side 2 mm, linewidth 400  $\mu\text{m}$
  - Side 1 mm, linewidth 300  $\mu\text{m}$
- Pentagonal path:
  - Side 2 mm, linewidth 300  $\mu\text{m}$
- 5% gel-collagen 1:1 + 0.2% GP
- Volumetric change < 6 %



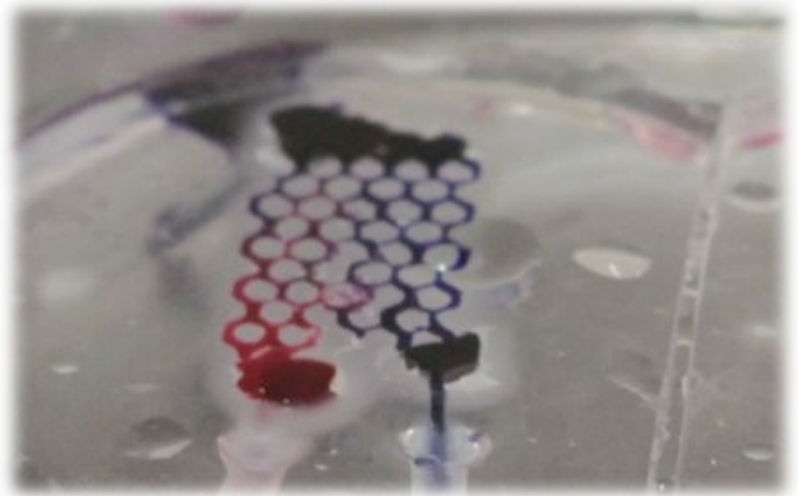
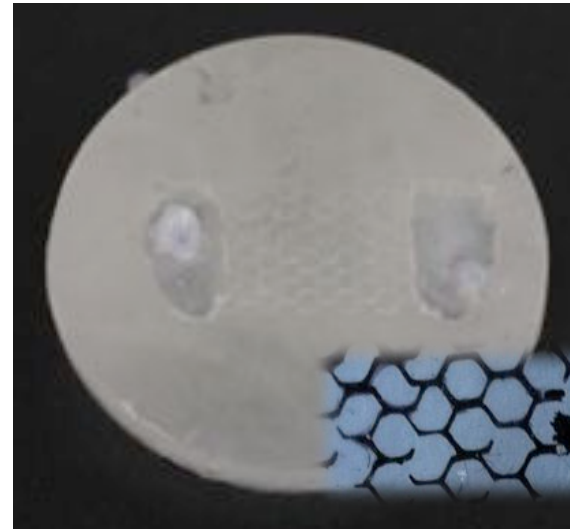
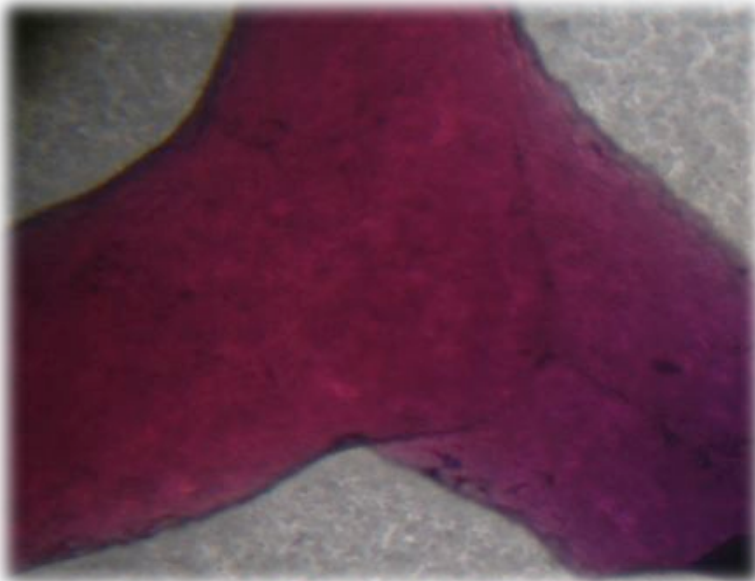
# + Low melting point mold for microfluidic devices

- Serpentine path
  - Length 20 mm, height 2
- Casting with 5% w/v gelatin gel crosslinked with genipin



# + Low melting point mold for microfluidic devices

- Hexagonal path
  - Side 2 mm, linewidth 400  $\mu\text{m}$
- Casting with PDMS



# **SHAPE DEPOSITION MANUFACTURING (SDM)**



# Shape Deposition Manufacturing



- Rapid production method with repetitive addition and selective removal of materials.
- It uses conventional machining facilities, hence also achieves the same order of machining tolerances.
- Multi-material parts can be created to compose functional mechanisms, also with embedded functional parts such as sensors and actuators.
- Cross-boundary embedding is the key for realizing highly integrated structures.

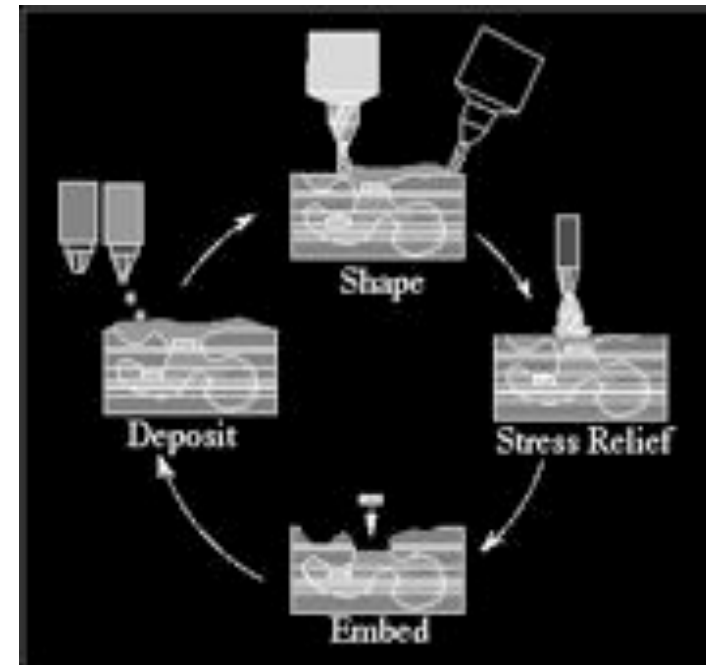




# Shape Deposition Manufacturing

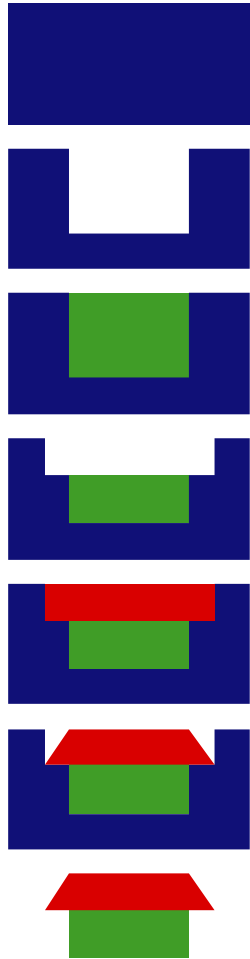


- Developed at Stanford & Carnegie Mellon
  - Is it a pure SFM process?
1. Deposition - material is added by plasma or laser based welding techniques
  2. Filler material is deposited around part and Material is shaped using conventional CNC
  3. Solid is stress relieved
  4. Components can be embedded
  5. Filler is removed to leave only finished part

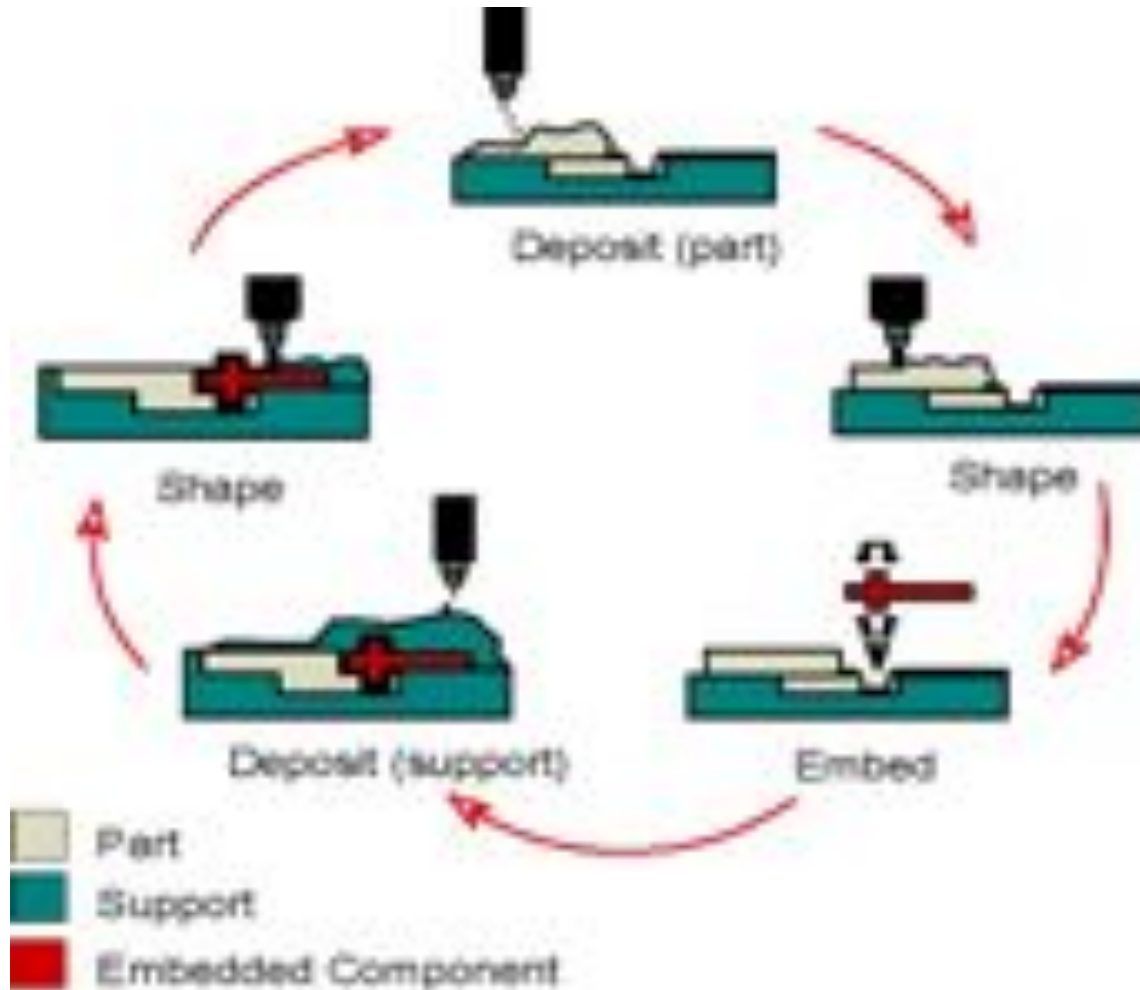




+ Why not add material in bulk and then selectively remove?



+ Why not add material in bulk and then selectively remove?



# + Comparison between common RP methods and SDM



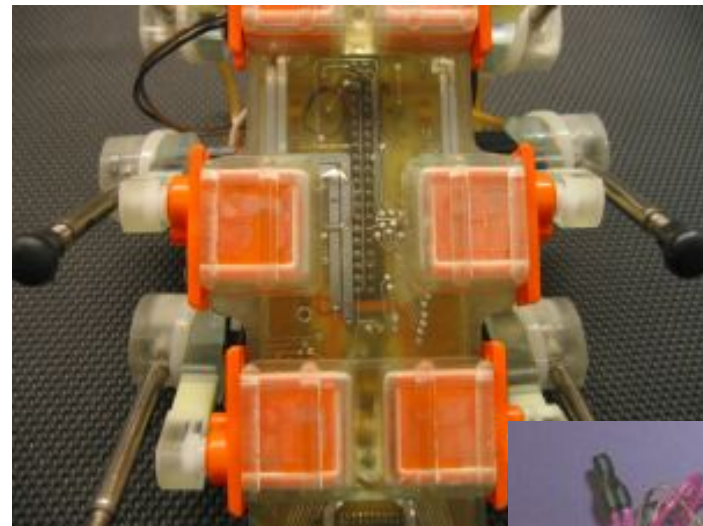
RP	SDM
<ul style="list-style-type: none"><li>– Limited material variation</li><li>– Limited fabrication tolerance</li><li>– Requires special equipment</li></ul>	<ul style="list-style-type: none"><li>– Wide variety of materials</li><li>– Fabrication tolerance comparable to conventional machining</li><li>– Conventional machining tools used.</li><li>– Can embed parts (sensors, actuators, reinforcement)</li></ul>

+

# SDM capabilities



Multi-material  
molding



Component  
embedding

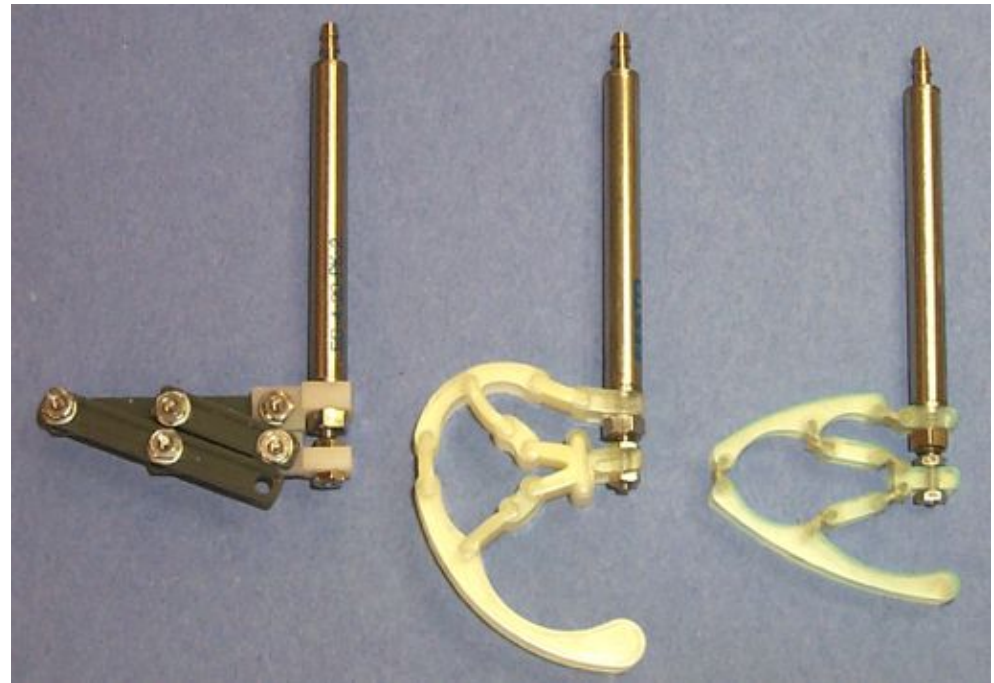




# Fabric-reinforced flexural hinges

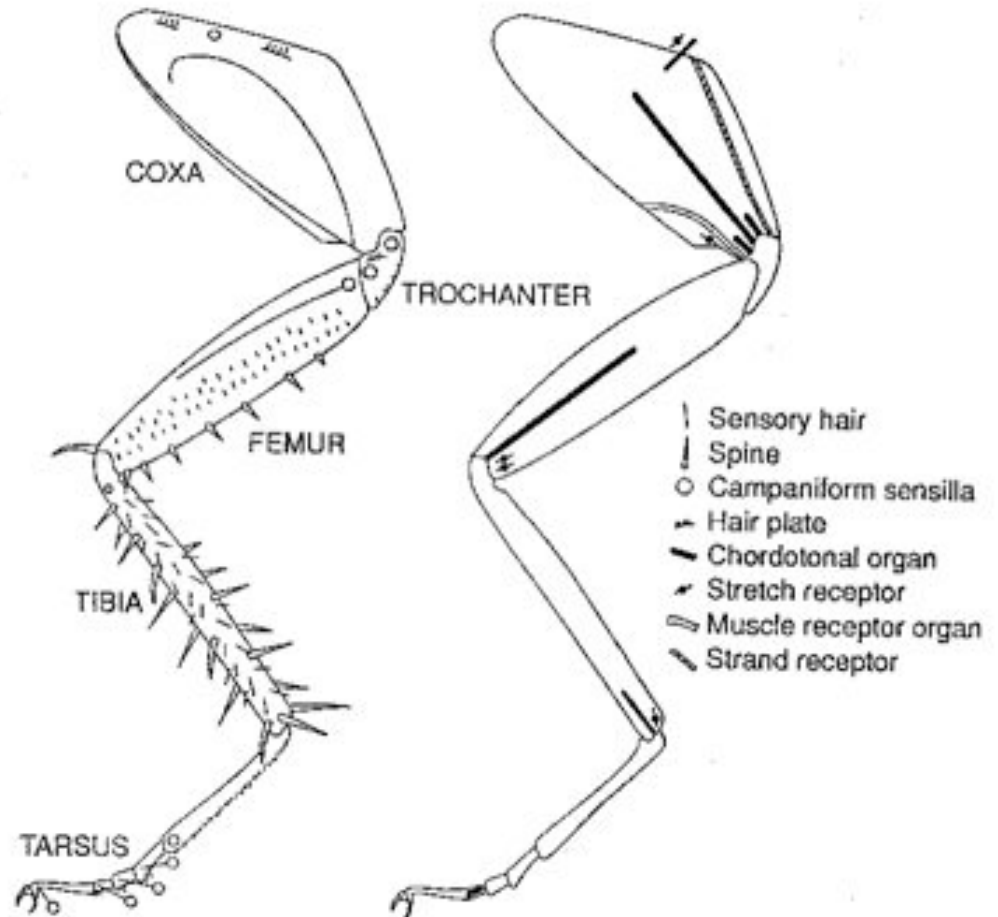


- Left: Kinematic prototype of stroke extension linkage with 31 parts
- Center: Single component SDM linkage with thick flexures
- Right: SDM linkage with thin fabric-reinforced flexures (2001)



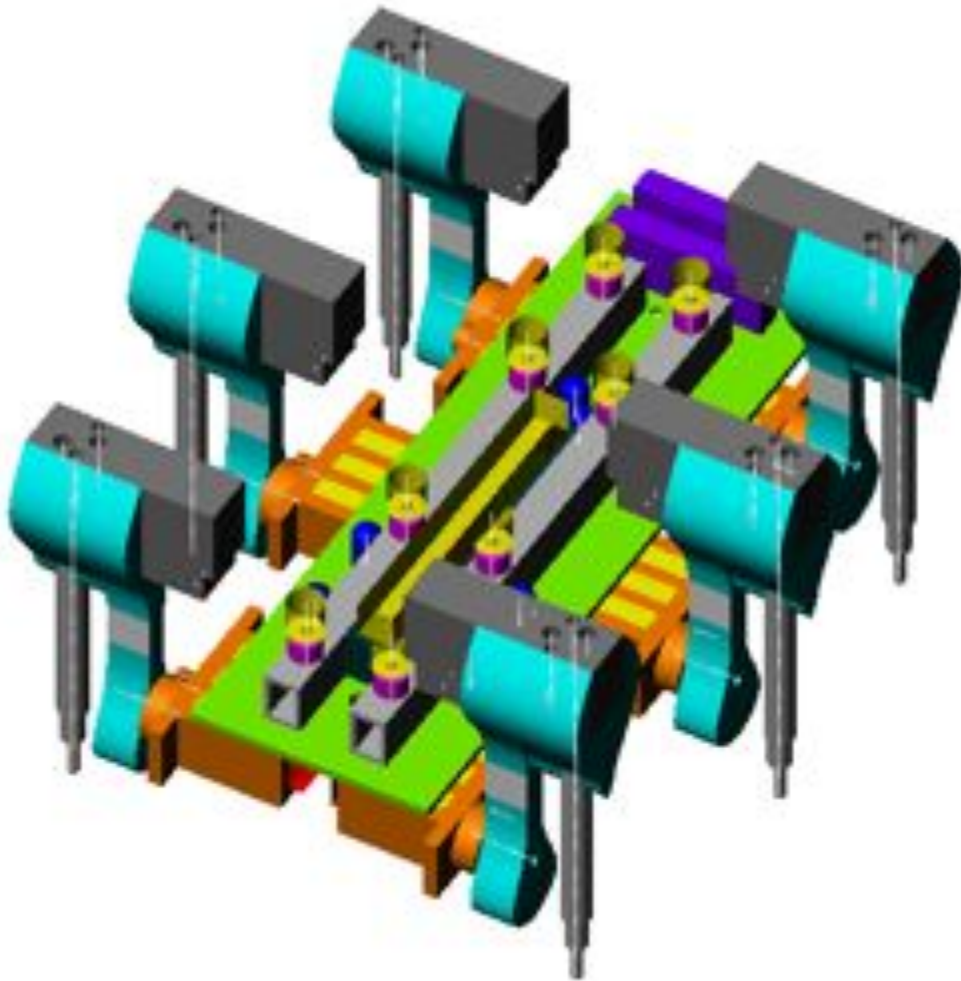
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# Biology is a target for complex integrated structures manufacturing



+

# SDM is suited for complex integration

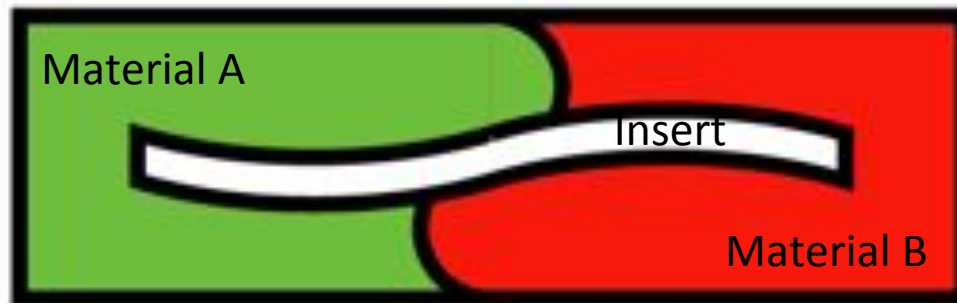


- Material properties can be locally altered by multi-material fabrication.
- Components can be assembled without fasteners, hence easier and more room for complex integration.
- Semi-automated process allows detailed fabrication.

+

# Cross-boundary embedding

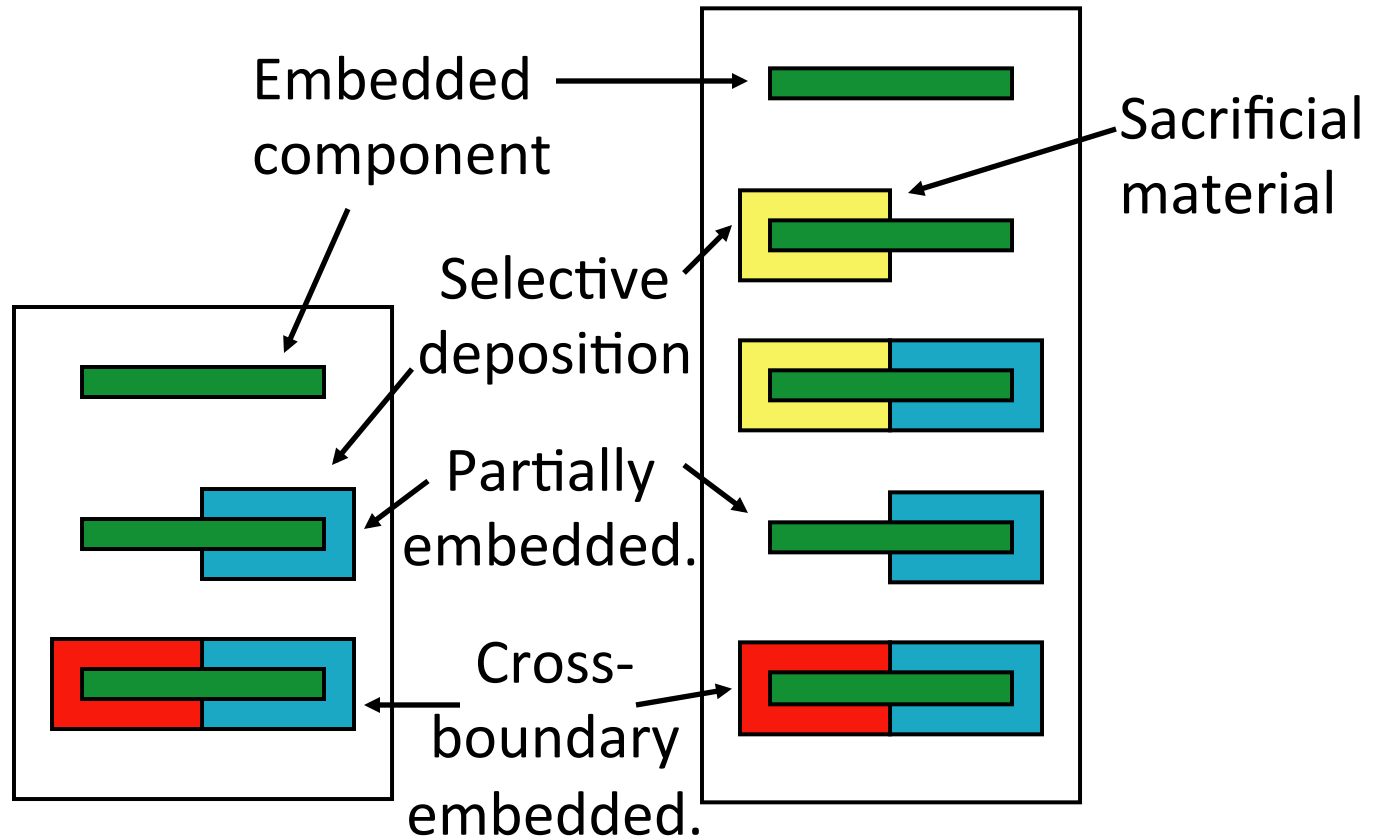
- Selectively adding, removing or otherwise processing material around the flexible strands without damaging them or being hindered by them.







# Selective deposition

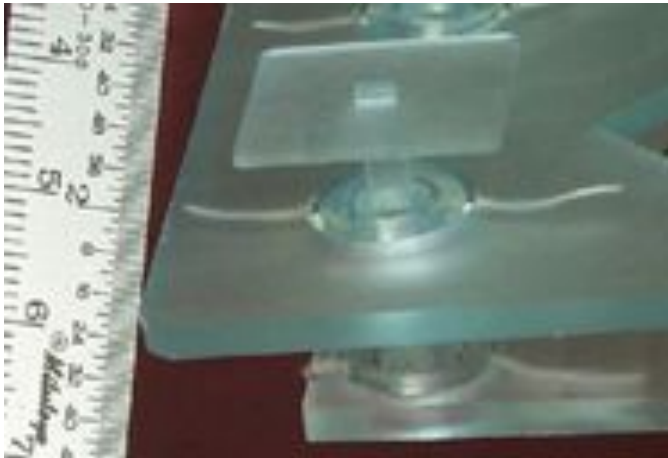


Selective deposition of part material

Selective deposition of sacrificial material

+

# Capillary effect for selective deposition

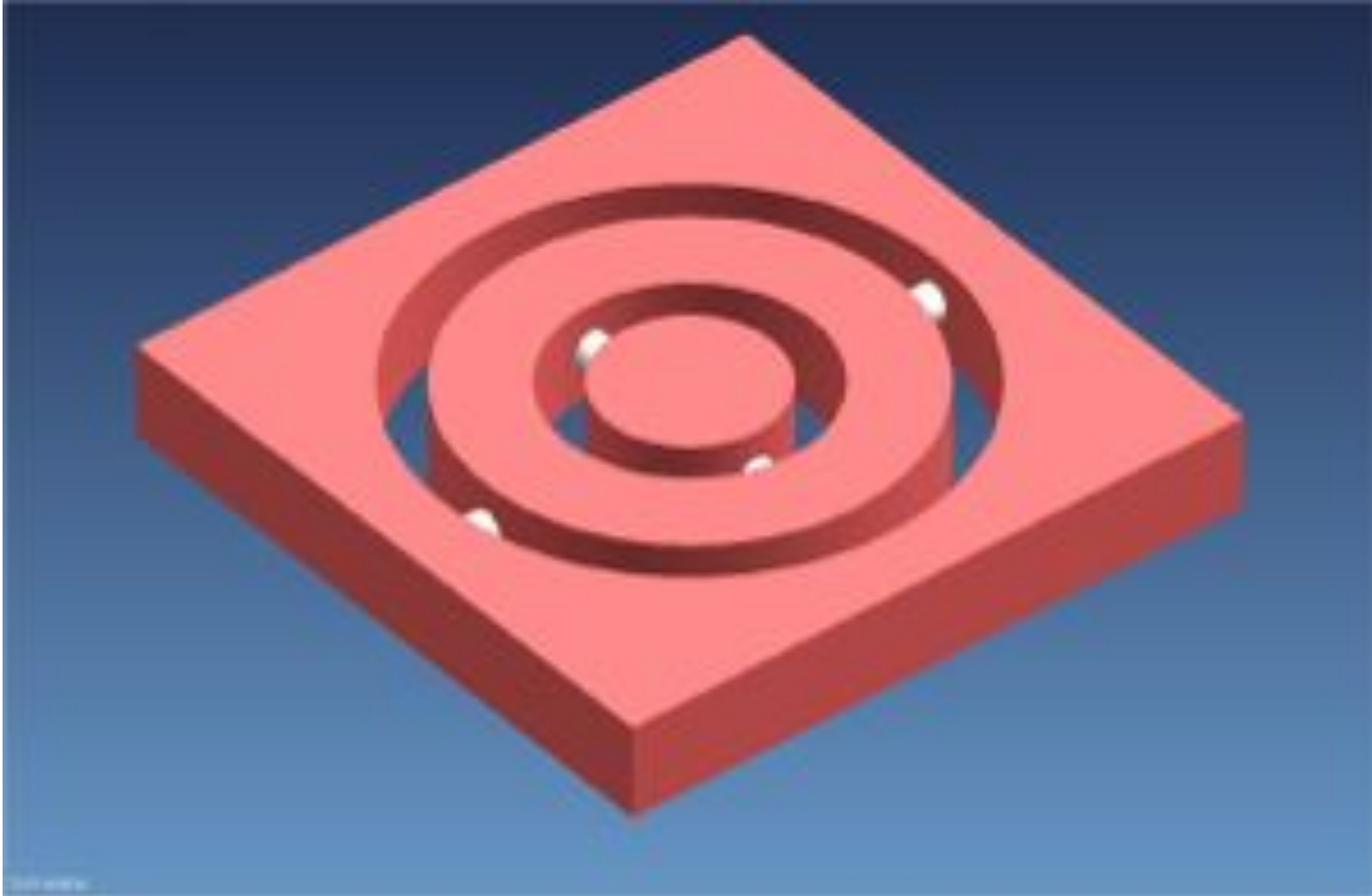


Example:

Small string-suspended gimbals with two rotational degrees of freedom. Developed for attitude control of solar panels on a small satellite (100mm-side cube).

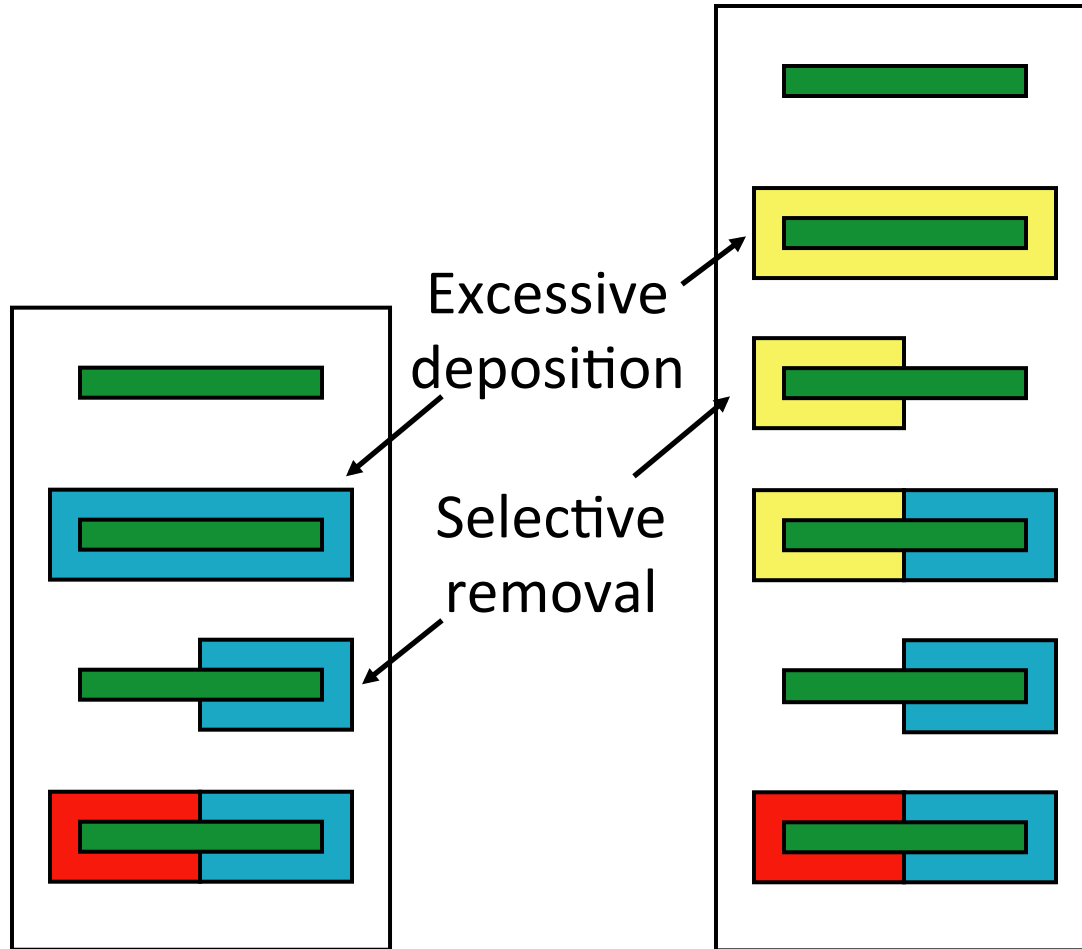
+

# Selective deposition





# Selective removal

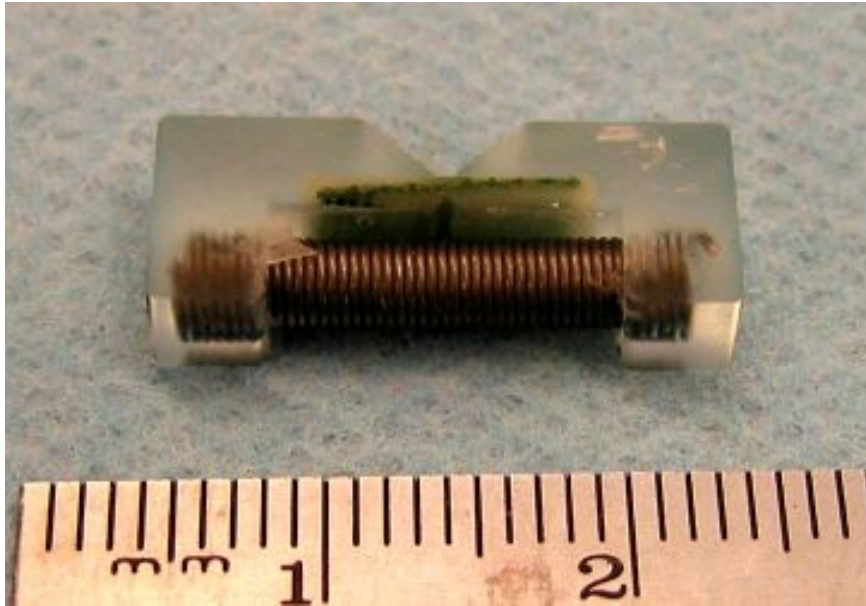


Selective removal of part material

Selective removal of sacrificial material



# Manual Selective Removal

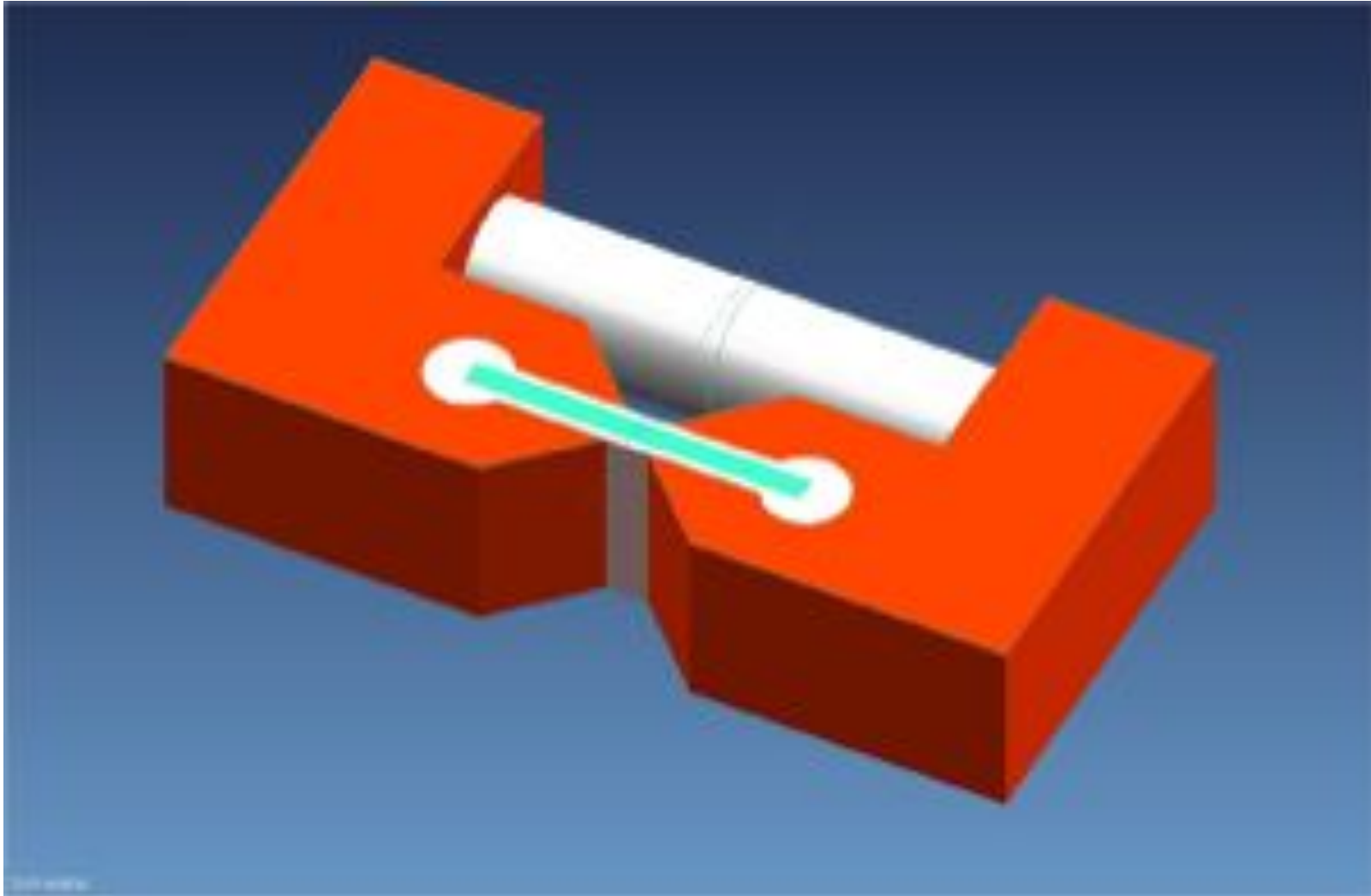


Example:

Spring-loaded hinge with partially embedded coil-spring and fiber-reinforced flexure. Developed for deploying solar-panels for a small satellite.

+

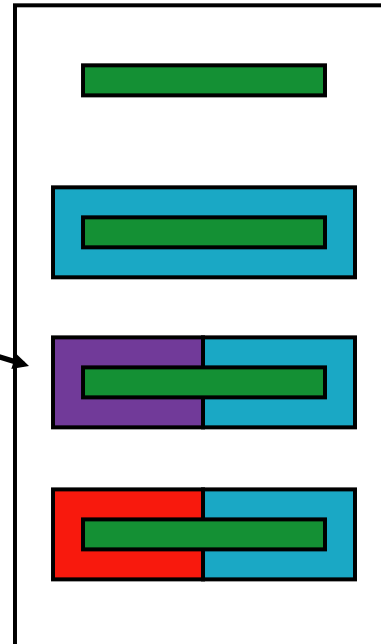
# Selective removal



# + Material property alteration by post-processing

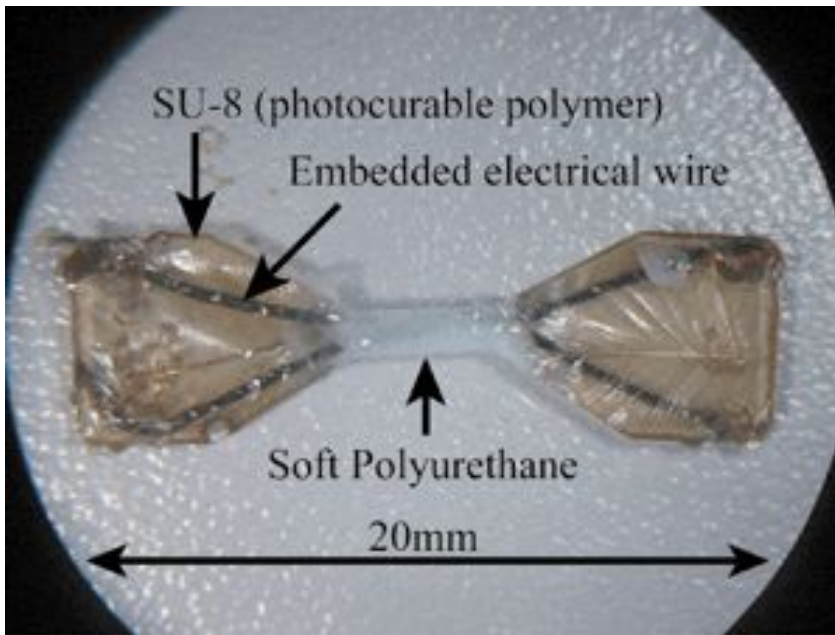


Material property alteration.  
E.g. by heat treatment, light exposure, or material addition.



+

# Selective removal by photo-lithography



Example:

A small flexural hinge with embedded electrical wires.



+

# Selective removal by photo-lithography

